

# 客户图

## NOTES:

1. FINISH:
  - 1.1 HOUSING: LCP BLACK,UL94V-0.
  - 1.2 CONTACT: BeCu,GOLD (SEE P/N) PLATED  
IN CONTACT AREA, MATTE TIN PLATED IN SOLDER AREA,  
50u" MIN. NICKEL UNDERPLATED OVERALL.
2. ELECTRICAL:
  - 2.1 CURRENT RATING: 1.34 A PER PIN(4 PINS POWERED).
  - 2.2 OPERATION TEMPERATURE:-55°C TO +125°C.
- 3.ORDER INFORMATION:

66B2-M XXX XX 013 R 01

Pin数码	端子电镀:	塑胶高度:	包装方式:
040=4*10PIN	S0=Gold Flash/Tin	013=1.30mm	R=载带包装
~	S1=1u" Gold/Tin		
400=4*100PIN	S2=3u" Gold/Tin		
	S3=5u" Gold/Tin		
	S4=10u" Gold/Tin		
	S6=30u" Gold/Tin		

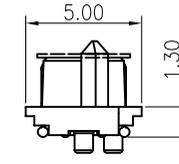
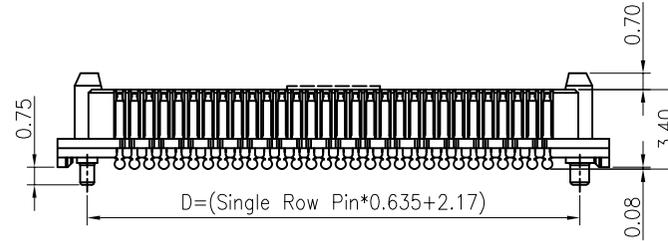
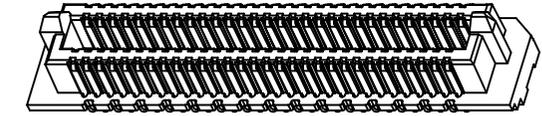
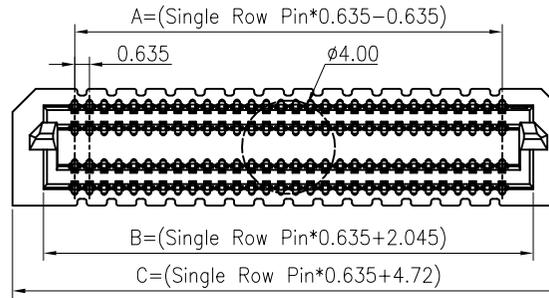
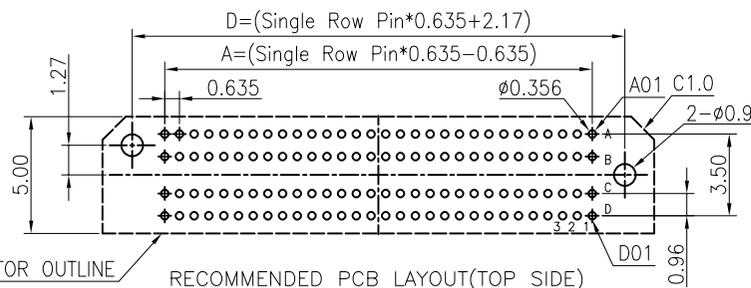
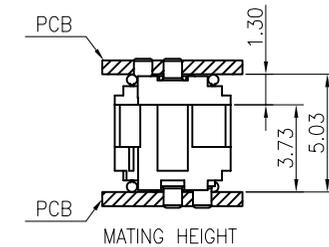
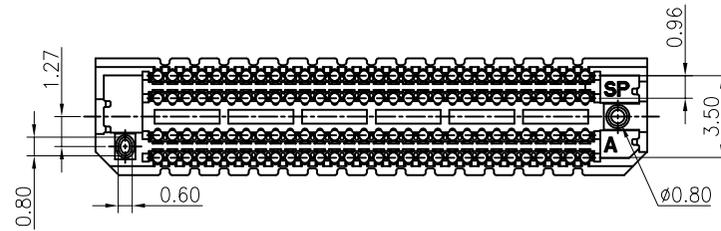


TABLE1:

No. OF PIN	A	B	C	D
040=4x10PIN	5.715	8.395	11.07	8.52
080=4x20PIN	12.065	14.745	17.42	14.87
120=4x30PIN	18.415	21.095	23.77	21.22
160=4x40PIN	24.765	27.445	30.12	27.57
200=4x50PIN	31.115	33.795	36.47	33.92
240=4x60PIN	37.465	40.145	42.82	40.27
280=4x70PIN	43.815	46.495	49.17	46.62
320=4x80PIN	50.165	52.845	55.52	52.97
360=4x90PIN	56.515	59.195	61.87	59.32
400=4x100PIN	62.865	65.545	68.22	65.67



CONNECTOR OUTLINE RECOMMENDED PCB LAYOUT(TOP SIDE)  
PCB BOARD TOLERANCE±0.05

				OPERATION		DRAW	WLY	2021.09.23		
				X.X	±0.40	DESIGN	Jensen	2021.09.23		
				X.XX	±0.25	CHECK	Jack	2021.09.23		
				X.XXX	±0.15	APPROVE	Andy	2021.09.23		
A0	NEW			Angle	±3°	UNIT	mm	SCALE	1:1	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1

**SOLEPIN** 东莞市硕品电子有限公司  
PROFESSIONAL CONNECTOR DONGGUAN SOLEPIN ELECTRONICS CO., LTD.

SIZE	A4	PART NO.	66B2-MXXXXX013R01
SHEET	1/1	TITLE:	0.635mm BTB 公头直立式 SMT
PROJ.	☞	DRAW NO.	SP-567

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 50u" MIN. NICKEL UNDERPLATED OVERALL.

2. ELECTRICAL:  
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 2.2 OPERATION TEMPERATURE:-55°C TO +125°C.

## 3.ORDER INFORMATION:

66B2-F XXX XX 037 R 01

Pin数码	端子电镀:	塑胶高度:	包装方式:
040=4*10PIN	S0=Gold Flash/Tin	037=3.73mm	R=载带包装
~	S1=1u" Gold/Tin		
400=4*100PIN	S2=3u" Gold/Tin		
	S3=5u" Gold/Tin		
	S4=10u" Gold/Tin		
	S6=30u" Gold/Tin		

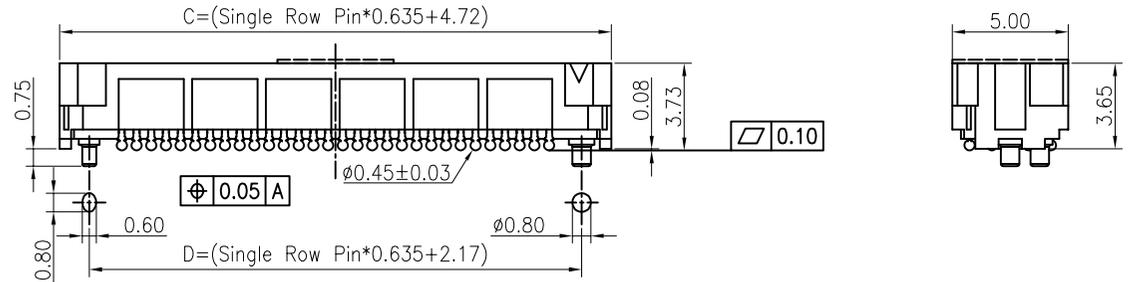
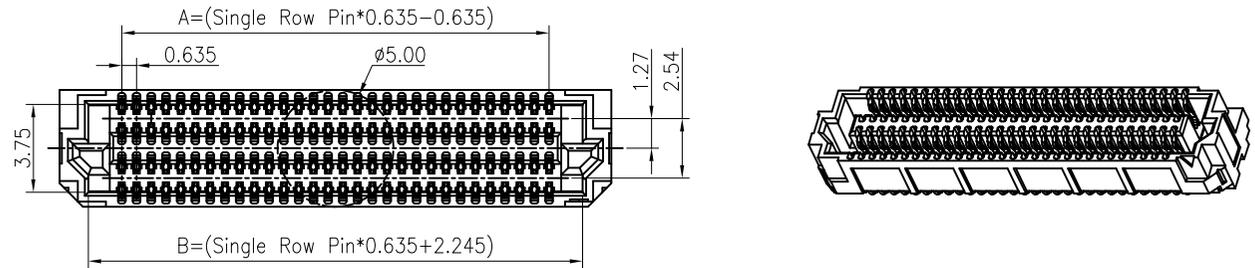
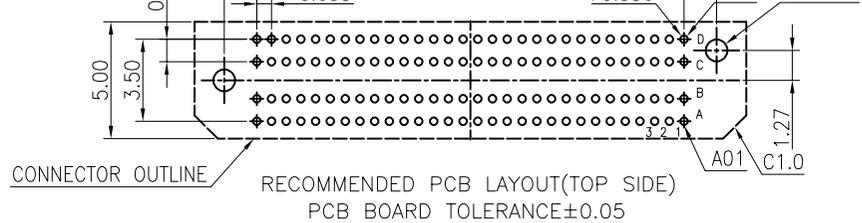
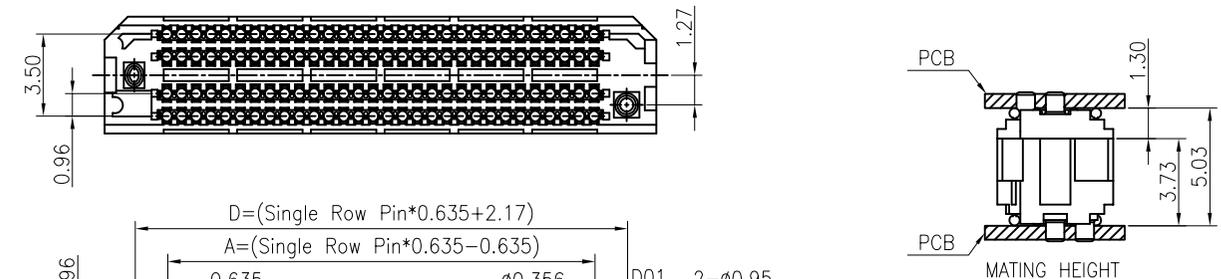


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360=4x90PIN	56.515	59.395	61.87	59.32
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				OPERATION		DRAW		WLY		2021.09.23		<b>SOLEPIN</b> 东莞市硕品电子有限公司			
				X.X ±0.40		DESIGN		Jensen		2021.09.23		PROFESSIONAL CONNECTOR DONGGUAN SOLEPIN ELECTRONICS CO., LTD.			
				X.XX ±0.25		CHECK		Jack		2021.09.23		SIZE	A4	PART NO.	66B2-FXXXXX037R01
				X.XXX ±0.15		APPROVE		Andy		2021.09.23		SHEET	1/1	TITLE:	0.635mm BTB 母座直立式 SMT
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.	⊕	DRAW NO.	SP-568
A0		NEW				Angle	±3°								